

# PC901V0NSZX

## Digital Output Type OPIC Photocoupler

### ■ Features

1. Normal ON operation, open collector output
2. TTL and LSTTL compatible output
3. Operating supply voltage ( $V_{CC}$ :3 to 15V)
4. Isolation voltage (Viso (rms):5kV)
5. High sensitivity  
( $I_{FLH}$ :MAX. 2.0mA at  $T_a=25^\circ\text{C}$ )
6. Under preparation for UL standard
7. 6-pin DIP package

### ■ Applications

1. Programmable controllers
2. PC peripherals
3. Electronic musical instruments

### ■ Absolute Maximum Ratings ( $T_a=25^\circ\text{C}$ )

	Parameter	Symbol	Rating	Unit
Input	Forward current	$I_F$	50	mA
	*1 Peak forward current	$I_{FM}$	1	A
	Reverse voltage	$V_R$	6	V
	Power dissipation	$P$	70	mW
Output	Supply voltage	$V_{CC}$	16	V
	High level output voltage	$V_{OH}$	16	V
	Low level output current	$I_{OL}$	50	mA
	Power dissipation	$P_O$	150	mW
	Total power dissipation	$P_{tot}$	170	mW
	*2 Isolation voltage	$V_{iso}$ (rms)	5	kV
	Operating temperature	$T_{opr}$	-25 to +85	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-40 to +125	$^\circ\text{C}$	
*3 Soldering temperature	$T_{sol}$	260	$^\circ\text{C}$	

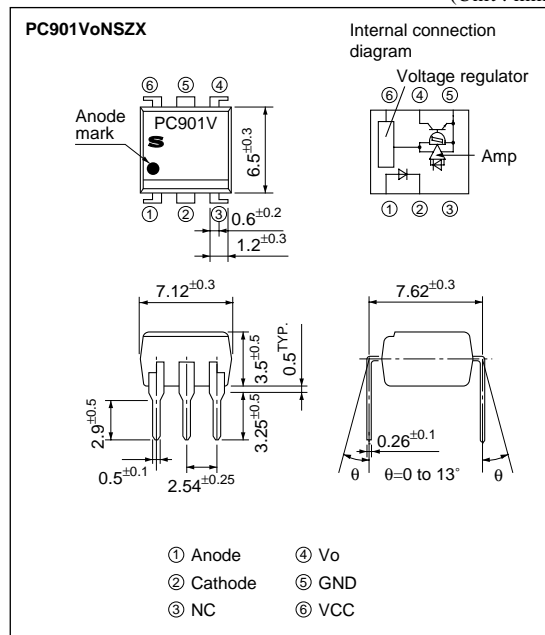
\*1 Pulse width $\leq$ 100 $\mu$ s, Duty ratio=0.001

\*2 40 to 60%RH, AC for 1 min

\*3 For 10 s

### ■ Outline Dimensions

(Unit : mm)



\* "OPIC"(Optical IC) is a trademark of the SHARP Corporation.  
An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

## ■ Electro-optical Characteristics

(Ta=0 to +70°C unless otherwise specified)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	$V_F$	$I_F=4\text{mA}$	–	1.1	1.4	V
			$I_F=0.3\text{mA}$	0.7	1.0	–	
	Reverse current	$I_R$	$T_a=25^\circ\text{C}$ , $V_R=4\text{V}$	–	–	10	$\mu\text{A}$
	Terminal capacitance	$C_t$	$T_a=25^\circ\text{C}$ , $V=0$ , $f=1\text{kHz}$	–	30	250	pF
Output	Operating supply voltage	$V_{CC}$		3	–	15	V
	Low level output voltage	$V_{OL}$	$I_{OL}=16\text{mA}$ , $V_{CC}=5\text{V}$ , $I_F=4\text{mA}$	–	0.2	0.4	V
	High level output current	$I_{OH}$	$V_O=V_{CC}=15\text{V}$ , $I_F=0$	–	–	100	$\mu\text{A}$
	Low level supply current	$I_{CCL}$	$V_{CC}=5\text{V}$ , $I_F=0$	–	2.5	5.0	mA
	High level supply current	$I_{CCH}$	$V_{CC}=5\text{V}$ , $I_F=4\text{mA}$	–	2.7	5.5	mA
	*4 "Low→High" threshold input current	$I_{FLH}$	$T_a=25^\circ\text{C}$ , $V_{CC}=5\text{V}$ , $R_L=280\Omega$	–	1.1	2.0	mA
			$V_{CC}=5\text{V}$ , $R_L=280\Omega$	–	–	4.0	
	*5 "High→Low" threshold input current	$I_{FHL}$	$T_a=25^\circ\text{C}$ , $V_{CC}=5\text{V}$ , $R_L=280\Omega$	0.4	0.8	–	mA
			$V_{CC}=5\text{V}$ , $R_L=280\Omega$	0.3	–	–	
	*6 Hysteresis	$I_{FHL}/I_{FLH}$	$V_{CC}=5\text{V}$ , $R_L=280\Omega$	0.5	0.7	0.9	–
Isolation resistance	$R_{ISO}$	$T_a=25^\circ\text{C}$ , DC=500V, 40 to 60% RH	$5 \times 10^{10}$	$10^{11}$	–	$\Omega$	
Transfer characteristics	*7 Response time	"Low→High" propagation delay time	$T_a=25^\circ\text{C}$ $V_{CC}=5\text{V}$ , $I_F=4\text{mA}$ $R_L=280\Omega$	–	1	3	$\mu\text{s}$
		"High→Low" propagation delay time		–	2	6	
		Rise time		–	0.1	0.5	
		Fall time		–	0.05	0.5	
	*8 Instantaneous common mode rejection voltage "Output : High level"	$CM_H$	$V_{CM}=600\text{V(peak)}$ , $V_O(\text{MIN.})=2\text{V}$ $I_F=4\text{mA}$ , $R_L=280\Omega$ , $T_a=25^\circ\text{C}$	–	–2 000	–	V/ $\mu\text{s}$
	*8 Instantaneous common mode rejection voltage "Output : Low level"	$CM_L$	$V_{CM}=600\text{V(peak)}$ , $V_O(\text{MAX.})=0.8\text{V}$ $I_F=0$ , $R_L=280\Omega$ , $T_a=25^\circ\text{C}$	–	2 000	–	V/ $\mu\text{s}$

\*4  $I_{FLH}$  represents forward current when output goes from low to high.\*5  $I_{FHL}$  represents forward current when output goes from high to low.\*6 Hysteresis stands for  $I_{FHL}/I_{FLH}$ .

\*7 Test circuit for response time is shown below.

\*8 Test circuit for  $CM_H$ ,  $CM_L$  shown below.

### Fig.1 Test Circuit for Response Time

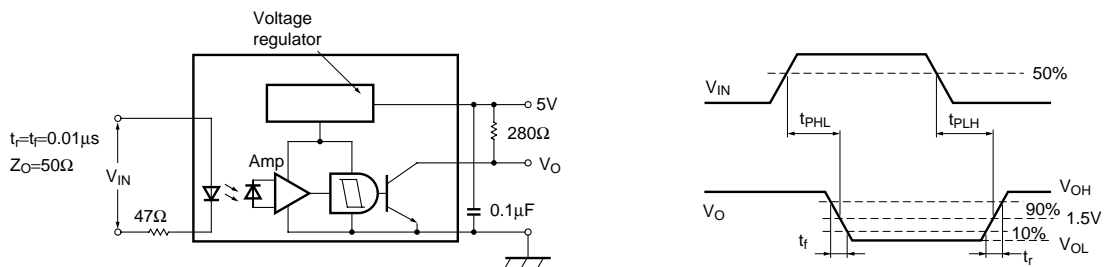


Fig.2 Test Circuit for CMH and CML

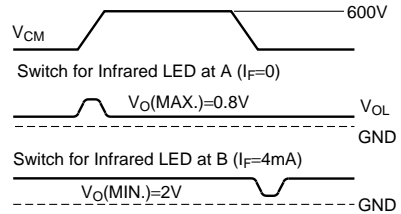
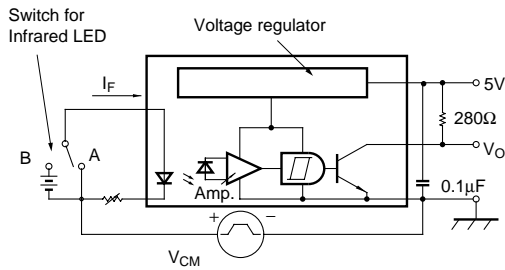


Fig.3 Forward Current vs. Ambient Temperature

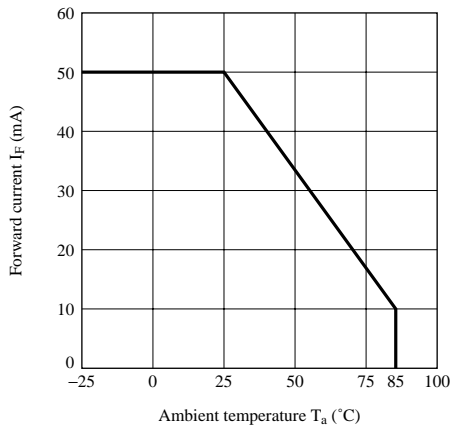


Fig.4 Power Dissipation vs. Ambient Temperature

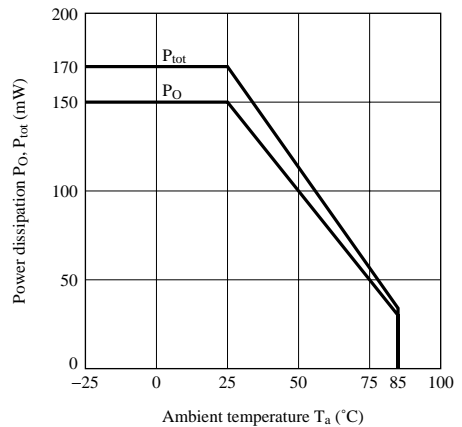


Fig.5 Forward Current vs. Forward Voltage

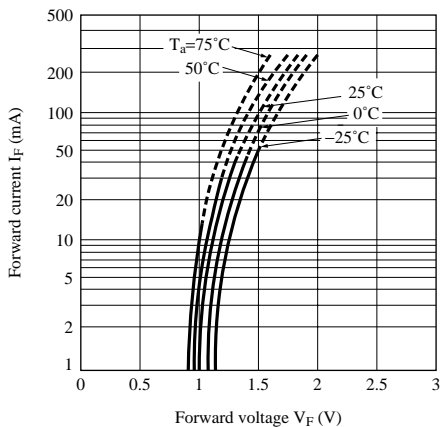
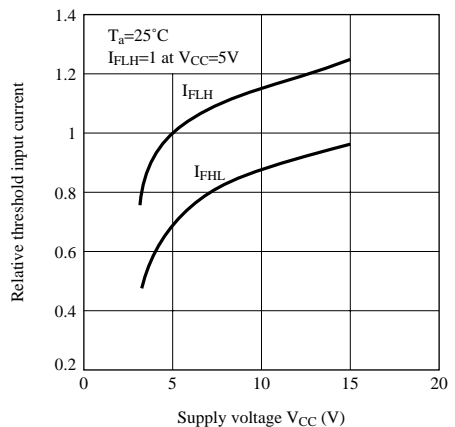
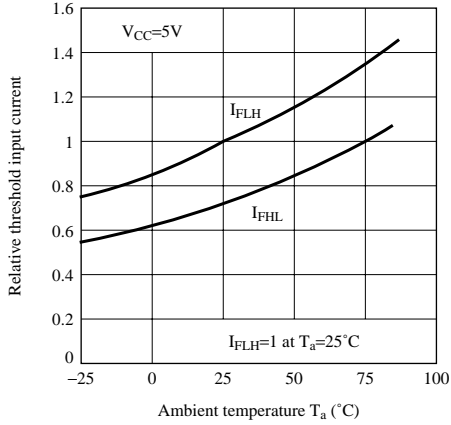


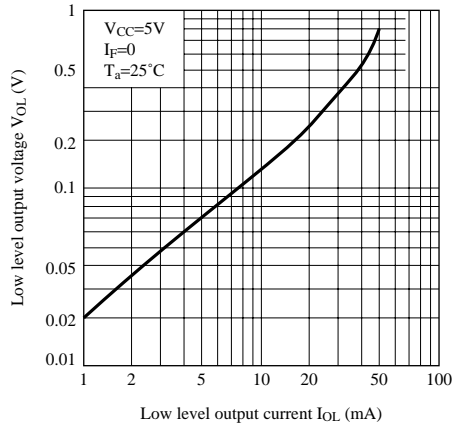
Fig.6 Relative Threshold Input Current vs. Supply Voltage



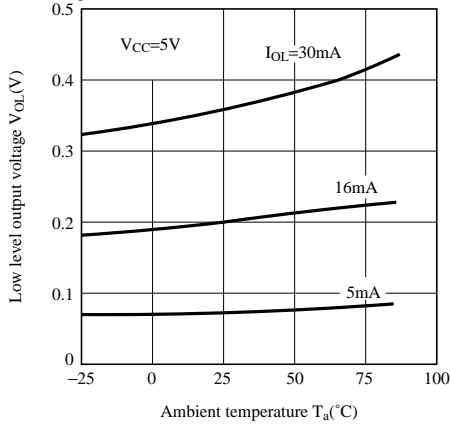
**Fig.7 Relative Threshold Input Current vs. Ambient Temperature**



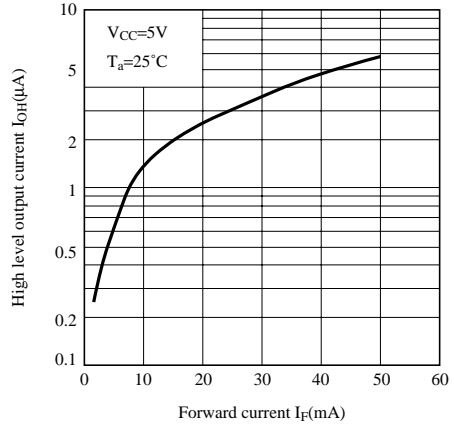
**Fig.8 Low Level Output Voltage vs. Low Level Output Current**



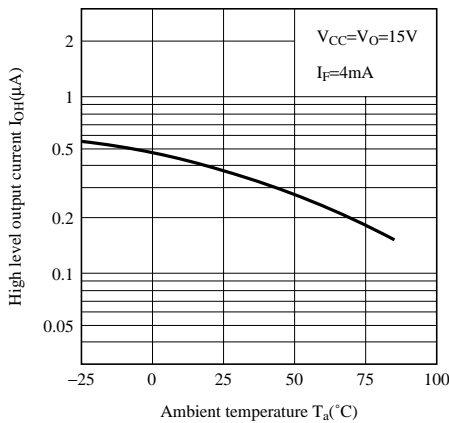
**Fig.9 Low Level Output Current vs. Ambient Temperature**



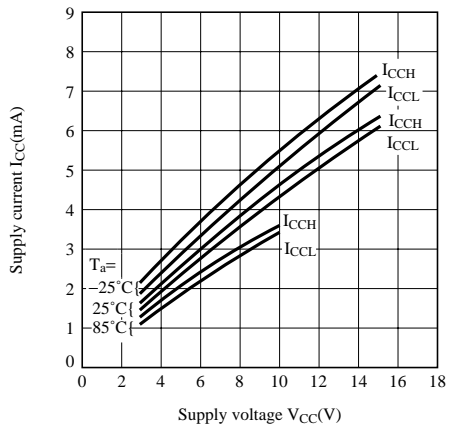
**Fig.10 High Level Output Current vs. Forward Current**



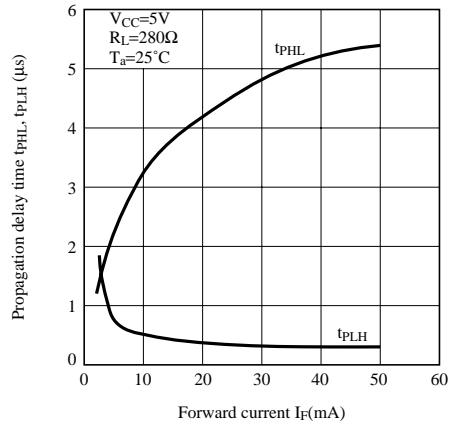
**Fig.11 High Level Output Current vs. Ambient Temperature**



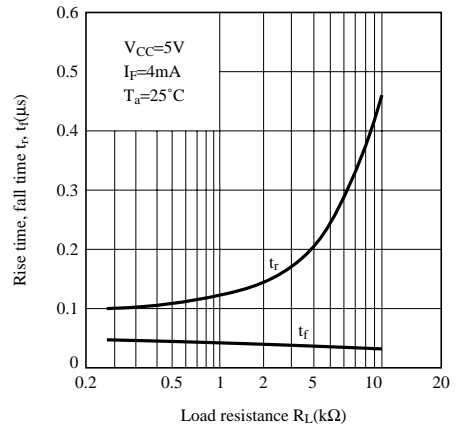
**Fig.12 Supply Current vs. Supply Voltage**



**Fig.13 Propagation Delay Time vs. Forward Current**



**Fig.14 Rise Time, Fall Time vs. Load Resistance**



### ■ Precautions for Use

1. It is recommended that a by-pass capacitor of more than  $0.01\mu F$  is added between  $V_{CC}$  and GND near the device in order to stabilize power supply line.
2. Handle this product the same as with other integrated circuits against static electricity.
3. As for other general cautions, please refer to the chapter "Precautions for Use".

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